

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant :	Georg Wittmann et al.	Art Unit :	2814
Serial No. :	10/816,718	Examiner :	Thao X. Le
Filed :	April 2, 2004	Conf. No. :	1015
Title :	FLEXIBLE MULTILAYER PACKAGING MATERIAL AND ELECTRONIC DEVICES WITH THE PACKAGING MATERIAL		

Mail Stop Amendment

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

REPLY TO ACTION OF NOVEMBER 9, 2007

In reply to the Office Action of November 9, 2007, Applicant submits the following remarks. Applicant understands that because the most recent submission by the applicant included an RCE and because new grounds of rejection have been presented, that the present action is a non-final office action. Both the "FINAL" and "non-final" boxes on the Office Action Summary page were checked. Applicant believes that only the "non-final" box was intended as being checked. Applicant respectfully requests reconsideration in view of these remarks.

Section 103 Rejections

Claims 17-30 and 36

Claims 17-30 and 36 were rejected under 35 U.S.C. § 103(a) as being allegedly unpatentable over U.S. Pat. No. 6,897,474 ("Brown") in view of U.S. Pat. No. 6,867,254 ("Wiercinski"). The applicant respectfully disagrees.

Claim 17 is directed to an organic electronic device with an active polymeric barrier layer that binds moisture and oxidizing agents and includes a material comprising a polymeric matrix with anhydrides.

Brown describes a device with multiple layers, including a planarizing material layer 111a and a high density material layer 112a (col. 11, lines 45-59). The high density material can be an inorganic material (col. 12, lines 33-47). The planarizing material can be a polymer (col. 12, lines 22-32).